

Single Phase Half Controlled Bridges

PSBZ 125

I_{dAV}
 V_{RRM}

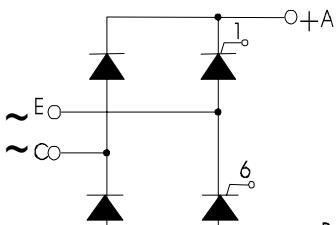
$$= 123 \text{ A}$$

$$= 400-1600 \text{ V}$$

Preliminary Data Sheet

V_{RSM}	V_{RRM}	Type
V_{DSM}	V_{DRM}	
500	400	PSBZ 125/04
900	800	PSBZ 125/08
1300	1200	PSBZ 125/12
1500	1400	PSBZ 125/14
*1700	*1600	PSBZ 125/16

* Delivery on request



Symbol Test Conditions

Maximum Ratings

Symbol	Test Conditions			Maximum Ratings	
I_{dAV}	$T_C = 85^\circ C$, module			123	A
I_{FSM}, I_{TSM}	$T_{VJ} = 45^\circ C$	$t = 10 \text{ ms}$	(50 Hz), sine	1500	A
	$V_R = 0$	$t = 8.3 \text{ ms}$	(60 Hz), sine	1600	A
$\int i^2 dt$	$T_{VJ} = T_{VJM}$	$t = 10 \text{ ms}$	(50 Hz), sine	1350	A
	$V_R = 0$	$t = 8.3 \text{ ms}$	(60 Hz), sine	1450	A
$(di/dt)_{cr}$	$T_{VJ} = 45^\circ C$	$t = 10 \text{ ms}$	(50 Hz), sine	11 200	$A^2 \text{ s}$
	$V_R = 0$	$t = 8.3 \text{ ms}$	(60 Hz), sine	10 750	$A^2 \text{ s}$
	$T_{VJ} = T_{VJM}$	$t = 10 \text{ ms}$	(50 Hz), sine	9100	$A^2 \text{ s}$
	$V_R = 0$	$t = 8.3 \text{ ms}$	(60 Hz), sine	8830	$A^2 \text{ s}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$	repetitive, $I_T = 50 \text{ A}$		150	$A/\mu\text{s}$
	$f = 400 \text{ Hz}$, $t_P = 200 \mu\text{s}$				
	$V_D = 2/3 V_{DRM}$				
	$I_G = 0.3 \text{ A}$	non repetitive, $I_T = 1/3 \cdot I_{dAV}$		500	$A/\mu\text{s}$
$R_{GK} = \infty$, method 1 (linear voltage rise)	$T_{VJ} = T_{VJM}$	$V_{DR} = 2/3 V_{DRM}$		1000	$V/\mu\text{s}$
	$I_T = I_{TAVM}$	$t_P = 500 \mu\text{s}$		≤ 5	W
P_{GM}	$T_{VJ} = T_{VJM}$	$t_P = 30 \mu\text{s}$		≤ 10	W
P_{GAVM}	$I_T = I_{TAVM}$	$t_P = 500 \mu\text{s}$		0.5	W
V_{RGM}				10	V
T_{VJ}			-40 ... + 125		$^\circ C$
T_{VJM}			125		$^\circ C$
T_{stg}			-40 ... + 125		$^\circ C$
V_{ISOL}	50/60 HZ, RMS	$t = 1 \text{ min}$		2500	$V \sim$
	$I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ s}$		3000	$V \sim$
M_d	Mounting torque		(M6)	5	Nm
	Terminal connection torque		(M6)	5	Nm
Weight	typ.			270	g

Features

- Package with screw terminals
 - Isolation voltage 3000 V~
 - Planar glasspassivated chips
 - Low forward voltage drop
 - UL released. E 148688

Applications

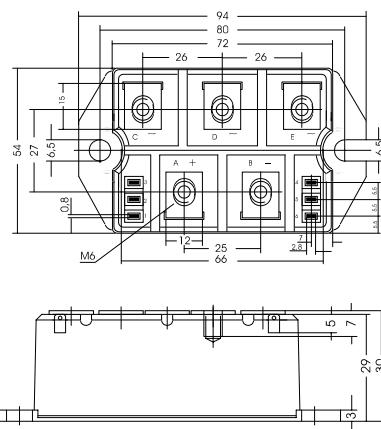
- Heat and temperature control for industrial furnaces and chemical processes
 - Lighting control
 - Motor control
 - Power converter

Advantages

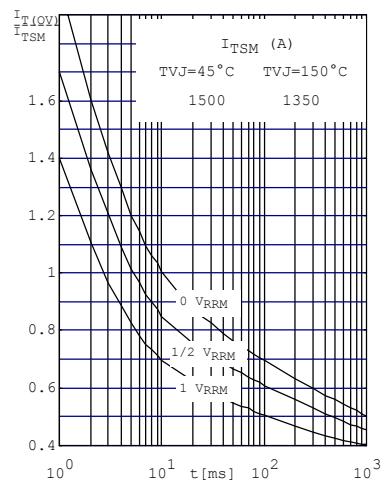
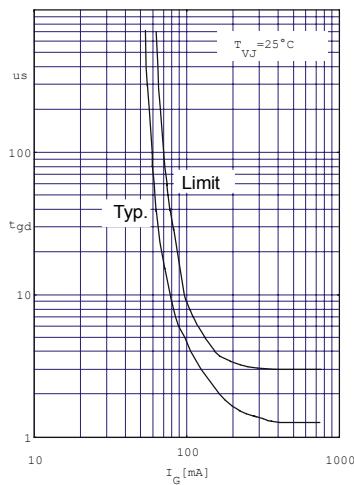
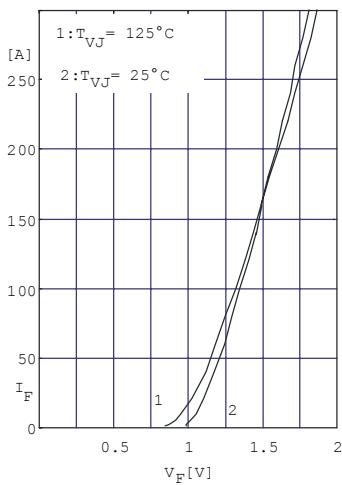
- Easy to mount with two screws
 - Space and weight savings
 - Improved temperature and power cycling capability
 - High power density

Package, style and outline

Dimensions in mm (1mm = 0.0394")



Symbol	Test Conditions		Characteristic Value		
I_D, I_R	$T_{VJ} = T_{VJM}$, $V_R = V_{RRM}$, $V_D = V_{DRM}$		\leq	5	mA
V_T	$I_T = 200A$, $T_{VJ} = 25^\circ C$		\leq	1.57	V
V_{TO}	For power-loss calculations only ($T_{VJ} = T_{VJM}$)			0.85	V
r_T				3.5	$m\Omega$
V_{GT}	$V_D = 6V$	$T_{VJ} = 25^\circ C$	\leq	1.5	V
		$T_{VJ} = -40^\circ C$	\leq	1.6	V
I_{GT}	$V_D = 6V$	$T_{VJ} = 25^\circ C$	\leq	100	mA
		$T_{VJ} = -40^\circ C$	\leq	200	mA
V_{GD}	$T_{VJ} = T_{VJM}$	$V_D = 2/3 V_{DRM}$	\leq	0.2	V
I_{GD}	$T_{VJ} = T_{VJM}$	$V_D = 2/3 V_{DRM}$	\leq	5	mA
I_L	$T_{VJ} = 25^\circ C$, $t_P = 30\mu s$ $I_G = 0.3A$, $dI_G/dt = 0.3A/\mu s$		\leq	450	mA
I_H	$T_{VJ} = 25^\circ C$, $V_D = 6V$, $R_{GK} = \infty$		\leq	200	mA
t_{gd}	$T_{VJ} = 25^\circ C$, $V_D = 1/2 V_{DRM}$ $I_G = 0.3A$, $dI_G/dt = 0.3A/\mu s$		\leq	2	μs
t_q	$T_{VJ} = T_{VJM}$, $I_T = 20A$, $t_P = 200\mu s$, $V_R = 100V$ $-di/dt = 10A/\mu s$, $dv/dt = 15V/\mu s$, $V_D = 2/3 V_{DRM}$			150	μs
R_{thJC}	per thyristor; sine $180^\circ el$			0.46	K/W
	per module			0.115	K/W
R_{thJK}	Per thyristor; sine $180^\circ el$			0.55	K/W
	per module			0.1375	K/W
d_s	Creeping distance on surface			10	mm
d_A	Creeping distance in air			9.4	mm
a	Max. allowable acceleration			50	m/s^2



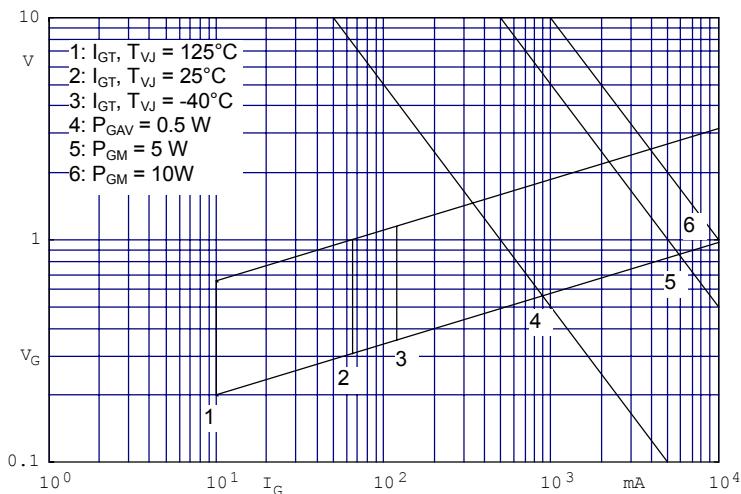


Fig.4 Gate trigger characteristic

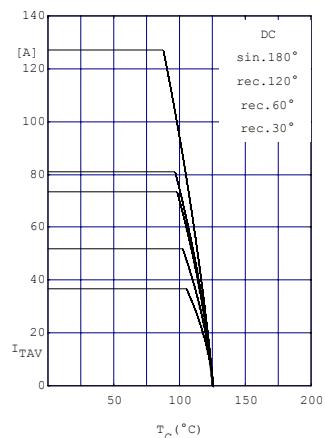


Fig.5 Maximum forward current at case temperature

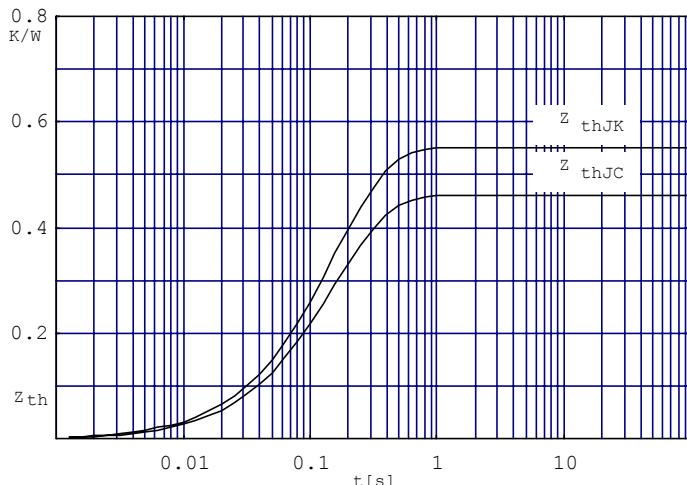


Fig.6 Transient thermal impedance per thyristor or diode (calculated)

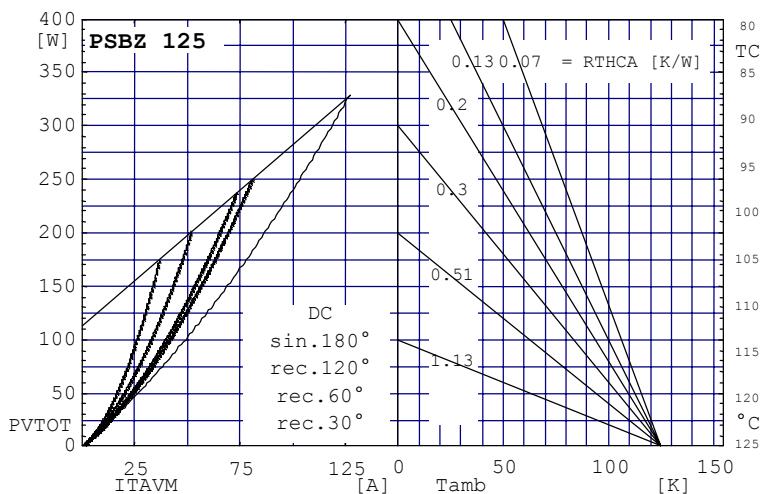


Fig. 7 Power dissipation vs. direct output current and ambient temperature